



MMBD2004SW

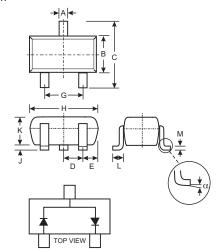
SURFACE MOUNT SWITCHING DIODE

Features

- Fast Switching Speed
- Surface Mount Package Ideally Suited for Automatic Insertion
- For General Purpose Switching Applications
- **High Conductance**
- Lead Free/RoHS Compliant (Note 3)
- "Green" Device, Note 4 and 5

Mechanical Data

- Case: SOT-323
- Case Material: Molded Plastic, "Green" Molding Compound, Note 5. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020C
- Terminals: Finish Matte Tin. Solderable per MIL-STD-202, Method 208
- Lead Free Plating (Matte Tin Finish annealed over Copper leadframe)
- Polarity: See Diagram
- Marking: KA9, See Page 2
- Ordering Information, see Page 2
- Weight: 0.006 grams (approximate)



SOT-323								
Dim	Min	Max						
Α	0.25	0.40						
В	1.15	1.35						
С	2.00	2.20						
D	0.65 Nominal							
E	0.30	0.40						
G	1.20	1.40						
Н	1.80	2.20						
J	0.0	0.10						
K	0.90	1.00						
L	0.25	0.40						
М	0.10	0.18						
α	0°	8°						
All Dimensions in mm								

Maximum Ratings @ T_A = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Repetitive Peak Reverse Voltage	V _{RRM}	300	V
Working Peak Reverse Voltage DC Blocking Voltage	$V_{RWM} \ V_{R}$	240	V
RMS Reverse Voltage	V _{R(RMS)}	170	V
Forward Continuous Current	IF	225	mA
Peak Repetitive Forward Current	I _{FRM}	625	mA
Non-Repetitive Peak Forward Surge Current @ t = 1.0μs @ t = 1.0s	I _{FSM}	4.0 1.0	А
Power Dissipation (Note 1)	Pd	250	mW
Thermal Resistance Junction to Ambient Air (Note 1)	$R_{\theta JA}$	500	°C/W
Operating and Storage Temperature Range	T _j , T _{STG}	-65 to +150	°C

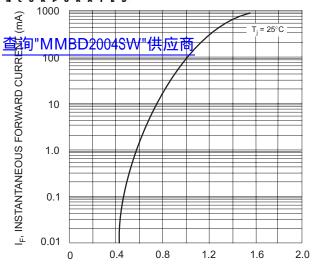
Electrical Characteristics @ TA = 25°C unless otherwise specified

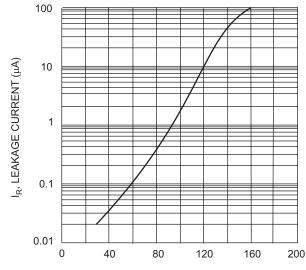
Characteristic	Symbol	Min	Max	Unit	Test Condition			
Reverse Breakdown Voltage (Note 2)	V _{(BR)R}	300	_	V	I _R = 100μA			
Forward Voltage	V _F	_	0.87 1.0	V	I _F = 20mA I _F = 100mA			
Peak Reverse Current (Note 2)	I _R	_	100	nA μA	V _R = 240V V _R = 240V, T _j = 150°C			
Total Capacitance, per Element	C _T	_	5.0	pF	V _R = 0, f = 1.0MHz			
Reverse Recovery Time	t _{rr}	_	50	ns	$I_F = I_R = 30 \text{mA},$ $I_{rr} = 3.0 \text{mA}, R_L = 100 \Omega$			

Notes:

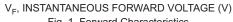
- 1. Part mounted on FR-4 board with recommended pad layout, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.
- 2. Short duration test pulse used to minimize self-heating effect.
- 3. No purposefully added lead.
- 4. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead_free/index.php.
- 5. Product manufactured with Date Code 0609 (week 9, 2006) and newer are built with Green Molding Compound. Product manufactured prior to Date Code 0609 are built with Non-Green Molding Compound and may contain Halogens or Sb2O3 Fire Retardants.

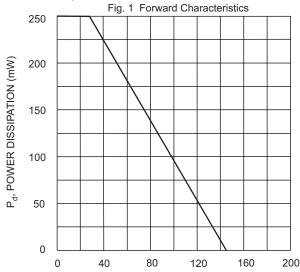






 T_{j} , JUNCTION TEMPERATURE (°C) Fig. 2 Leakage Current vs Junction Temperature





T_A, AMBIENT TEMPERATURE (°C) Fig. 3 Power Dissipation Derating

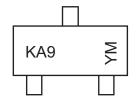
Ordering Information (Note 5 & 6)

Device	Packaging	Shipping		
MMBD2004SW-7-F	SOT-323	3000/Tape & Reel		

Notes: 5. Product manufactured with Date Code 0609 (week 9, 2006) and newer are built with Green Molding Compound. Product manufactured prior to Date Code 0609 are built with Non-Green Molding Compound and may contain Halogens or Sb2O3 Fire Retardants.

6. For Packaging Details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information



KA9 = Product Type Marking Code YM = Date Code Marking Y = Year ex: T = 2006

M = Month ex: 9 = September

Date Code Key

Year 2003 2004 2005 2006 2007 2008 2009 2010 2011 2012 Code R S U Χ Ζ

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



IMPORTANT NOTICE

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